Si4943CDY

RoHS

COMPLIANT

HALOGEN

FREE

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Vishay Siliconix

SO-8 Dual D_2 D_2 5 D, 6 D, 8 G. S. Top View

PRODUCT SUMMARY					
V _{DS} (V)	-20				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0192				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0330				
Q _g typ. (nC)	20				
I _D (A) ^{a, e}	-8				
Configuration	Dual				

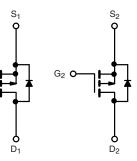
FEATURES

Dual P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load switching
- Computer
- Game systems
- Battery switching
- 2-cell Li-ion



P-Channel MOSFET

P-Channel MOSFET

ORDERING INFORMATION

Package	SO-8
Lead (Pb)-free and halogen-free	Si4943CDY-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A	= 25 °C, unless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-20	V
Gate-source voltage		V _{GS}	± 20	v
	T _C = 25 °C		-8 ^e	
Continuous drain surrant (T 150 °C)	T _C = 70 °C		-8 e	
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	-8 b, c, e	
	T _A = 70 °C		-6.7 ^{b, c}	
Pulsed drain current (10 µs pulse width)	·	I _{DM}	-30	A
Source-drain current diode current	T _C = 25 °C		-2.5	
	T _A = 25 °C	I _S	-1.7 ^{b, c}	
Pulsed source-drain current		I _{SM}	-30	
Single pulse avalanche current		I _{AS}	-11	
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	6	mJ
Maximum power dissipation	T _C = 25 °C		3.1	
	T _C = 70 °C		2	
	T _A = 25 °C	P _D	2 ^{b, c}	W
	T _A = 70 °C	1	1.28 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-50 to +150	°C

THERMAL RESISTANCE RATINGS

			LIMIT		
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	50	62.5	°C/W
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	30	40	0/10

Notes

a. Based on $T_C = 25 \ ^{\circ}C$ b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 110 °C/W

e. Package limited

S09-0704-Rev. B, 27-Apr-09

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Document Number: 69985

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.A	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050	-	-21	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	5.4	-		
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-3	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	-100	nA	
Zava gata valtaga drain avvent	I _{DSS}	$V_{DS} = -20 V, V_{GS} = 0 V$	-	-	-1	μΑ	
Zero gate voltage drain current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
On-state drain current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = -10 V$	-30	-	-	А	
Drain acurac an state registered b		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -8.3 \text{ A}$	-	0.0160	0.0192	Ω	
Drain-source on-state resistance ^b	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -6.4 \text{ A}$	-	0.0275	0.0330		
Forward transconductance b	9 _{fs}	V _{DS} = -10 V, I _D = -8.3 A	-	19	-	S	
Dynamic ^a			•			•	
Input capacitance	C _{iss}		-	1945	-	pF	
Output capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	460	-		
Reverse transfer capacitance	C _{rss}		-	385	-		
Tababa ata ata an	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -8.3 \text{ A}$	-	41	62	nC	
Total gate charge			-	20	30		
Gate-source charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_{D} = -8.3 A	-	7	-		
Gate-drain charge	Q _{gd}		-	9	-		
Gate resistance	Rg	f = 1 MHz	0.5	2.5	5	Ω	
Turn-on delay time	t _{d(on)}		-	13	20		
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	11	17		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -6.7 A, V_{GEN} = -10 V, R_g = 1 Ω	-	35	53		
Fall time	t _f		-	10	15		
Turn-on delay time	t _{d(on)}		-	50	75	ns	
Rise time	t _r	V_{DD} = -10 V, R _L = 1.5 Ω	-	71	107]	
Turn-off delay time	t _{d(off)}	$I_D \cong -6.7$ Å, $V_{GEN} = -4.5$ V, $R_g = 1 \Omega$	-	29	44		
Fall time	t _f		-	15	23		
Drain-Source Body Diode Characteris	tics		•			•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-2.5	•	
Pulse diode forward current ^a	I _{SM}		-	-	-30	A	
Body diode voltage	V _{SD}	I _S = -6.7 A	-	-0.77	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	30	45	ns	
Body diode reverse recovery charge	Q _{rr}		-	17	26	nC	
Reverse recovery fall time	t _a	- I _F = - 6.7 A, di/dt = 100 A/µs, T _J = 25 °C		13	-		
Reverse recovery rise time	t _b		-	17	-	ns	

Notes

a. Guaranteed by design, not subject to production testing

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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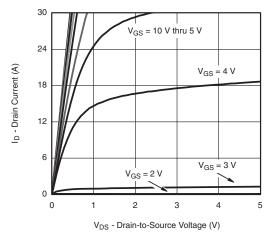
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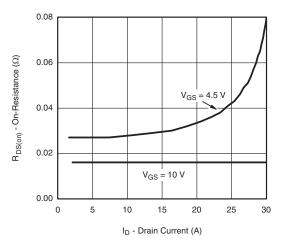


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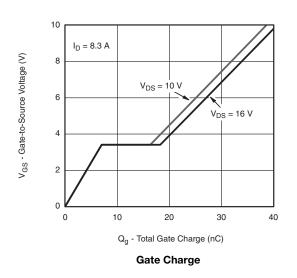
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

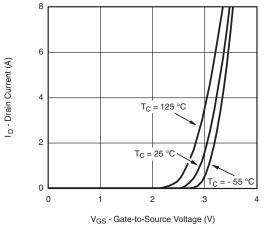


Output Characteristics



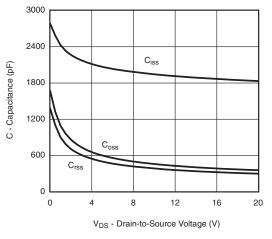
On-Resistance vs. Drain Current and Gate Voltage



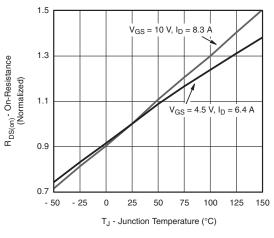


S - Gale-10-Source voltage (V)

Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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Si4943CDY

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I_D = 8.3 A

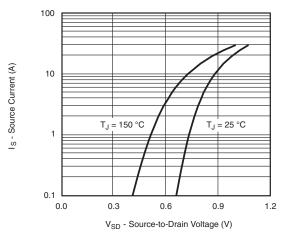
T_J = 125 °C

T_J = 25 °C

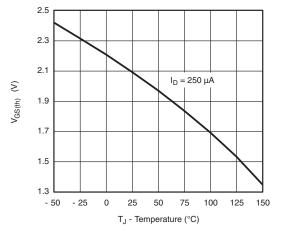
20

10

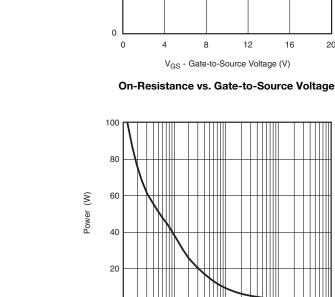
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Source-Drain Diode Forward Voltage



Threshold Voltage



0

0.001

0.01

0.04

0.03

0.02

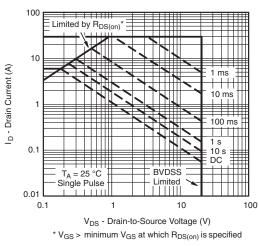
0.01

R $_{DS(on)}$ - On-Resistance (Ω)

Time (s) Single Pulse Power, Junction-to-Ambient

0.1

1



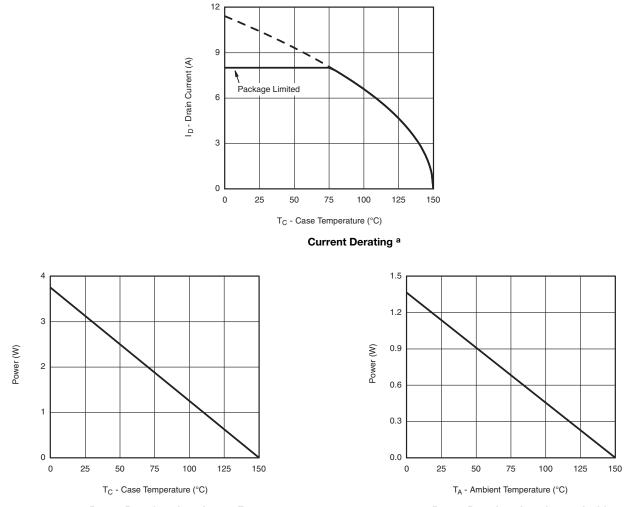
Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient

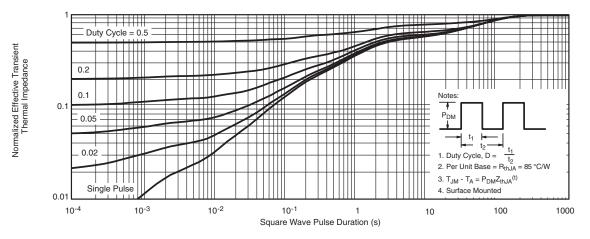
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

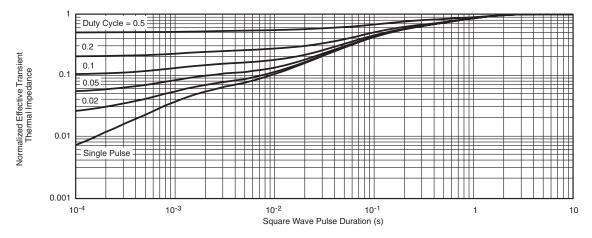


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69985.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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